



ICD-3000-OEM

2022-06-22

Exports: [Export Summary Sheet](#)

EULA: [End User License Agreement](#)


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 **CAUTION:** Alerts to a potential hazard that may result in personal injury, or an unsafe practice that causes damage to the equipment if not avoided.

 **IMPORTANT:** Identifies crucial information that is important to setup and configuration procedures.

 *Used to emphasize points or reminds the user of something. Supplementary information that aids in the use or understanding of the equipment or subject that is not critical to system use.*



Revision History

| Date | Description |
|------------|--|
| 2022-06-22 | Removed note about single DSP mode in Thermal Management section. |
| 2022-05-27 | Added caution note to disconnect the power before connecting or disconnecting cables. |
| 2022-01-21 | Removed power consumption note in Thermal Management section that was only specific to REV C. |
| 2021-09-22 | Added serial port and GPIO tables to Additional I/O section. |
| 2021-08-05 | Clarified description of GPIO file paths. Added J6 and J9 connectors for the 4000-OEM to Camera Input Adapter Board IDs section. |
| 2021-03-04 | Corrected BT.656 generic digital on VIN1 from Cam1 to Cam2. |
| 2020-12-15 | Moved Camera Input Adapter Board ID table to ICD-3000-4000-Adapter Boards. |
| 2020-12-07 | Updated 3000-OEM Hardware Revision section. Added new links to revision drawings and STEP files. |
| 2020-05-18 | Added note that 8-bit BT.656 on pins 15-22 is used for generic digital camera switch. |
| 2020-01-24 | Added max voltage, current and main power connector notation to pins 55, 57, 59, 61. |
| 2020-01-22 | Added note on J1 that Video 1 is used for S-Video, not supported. |
| 2019-10-17 | Added voltage qualification note to specifications. |
| 2019-10-04 | Update BT.656 to use Port B for data. Remove references to 8-bit inputs as our capture does not support. |
| 2019-09-09 | Corrected GPIO descriptions in Ports, LED, GPIO and Sensors section. |
| 2019-03-22 | Added Caution statement on board modifications. |
| 2019-01-24 | Added application notes in the Gap Pad and Gap Filler (Thermal Grease) sections. |
| 2019-01-23 | Added reference notes for capacitive coupling in Ethernet section. Updated connector J3 and J4 sections to note that inputs are 3.3V, and VIOSEL translation is done on external adapter boards. |
| 2018-12-20 | Remove reference to Vout1. This second video output is not available. |
| 2018-12-12 | Updated Temperature Sensor section with temperature related commands from the IDD. |
| 2018-11-27 | Added note to use Port A for BT.656 inputs. |
| 2018-10-31 | Added 3000-OEM Thermal Pad drawing and pad table to Gap Pads section. |
| 2018-10-25 | Add notes on J2: Video Output signals. |
| 2018-09-25 | Updated information on altering the corners of the PCB board. |
| 2018-09-10 | Added supply voltage level compatibility statement for camera boards. |
| 2018-08-23 | Added VOUT supported resolutions. |
| 2018-08-22 | Updated Video Input Port description. |
| 2018-07-03 | Updated LED Summary section. |
| 2018-05-22 | Added notes explaining D2/D3 LED functions to LED Summary section. |
| 2018-03-09 | Added input voltage note to Specifications. Added details on Port ID and Board ID. |
| 2017-12-20 | Added notes on thermal and magnetics. |
| 2017-07-28 | Added notes on generic adapter ID, GPIO pin and reset/power-down lines. |
| 2017-05-18 | Added notes on minimum vertical blanking. |
| 2017-04-28 | Added in video timing diagram for 1080P as an example. |
| 2017-04-27 | Corrected HDVPSS timing information. |
| 2017-04-26 | Added detailed information on synchronization edges, maximum input pixel clock, reference to TI HDVPSS input timing documentation. |
| 2017-04-24 | Added section detailing how to measure blanking. |
| 2017-04-22 | Added section on synchronization signals and blanking. |
| 2017-02-16 | Added section on supported camera data formats. |
| 2017-02-07 | Added Port A and Port B data bit locations to VIP ports. |
| 2017-01-10 | Specify grayscale input data bit locations. Add notes on I2C Linux bus numbering. |
| 2016-09-09 | Added temperature sensor information. |
| 2016-08-01 | Updated Preliminary Junction-to-Case Thermal Resistance (Theta-JC) section. |
| 2016-05-10 | Added notes on grayscale support. |
| 2016-02-04 | Added notes regarding serial port voltage levels and Ethernet 10/100. |



1 Overview

Describes power requirements, thermal management, interface specifications, and connector pinouts for the 3000-OEM video processing board.

CAUTION: Any customer modifications to SightLine OEM and adapter boards will void the warranty and can potentially damage the board. Before attempting any modifications, please contact [Support](#).

1.1 Additional Support Documentation

Additional Engineering Application Notes (EANs) can be found on the [Documentation](#) page of the SightLine Applications website.

The [Panel Plus User Guide](#) provides a complete overview of settings and dialog windows located in the Help menu of the Panel Plus application.

The Interface Command and Control (IDD) describes the native communications protocol used by the SightLine Applications product line. The IDD is also available as a PDF download on the [Documentation](#) page under Software Support Documentation.

1.2 Sightline Software Requirements

Panel Plus software and firmware versions:

3000-OEM requires Panel Plus and Firmware 2.23.0 and higher. REV C requires Panel Plus and firmware 2.24.xx and higher.

IMPORTANT: The Panel Plus software version should match the firmware version running on the board. Firmware and Panel Plus software versions are available on the [Software Download](#) page.

2 Safe Device Handling

CAUTION: To prevent damage to hardware boards, disconnect all input power to OEMs and adapter boards before connecting or disconnecting cables including all FFC, FPC, KEL, HDMI, and round wire (Molex) cables.

CAUTION: To prevent damage to hardware boards, use a conductive wrist strap attached to a good earth ground. Before picking up an ESD sensitive electronic component, discharge built up static by touching a grounded bare metal surface or approved antistatic mat.

3 3000-OEM Overview

The 3000-OEM has four connectors on the bottom side that are designed for board-to-board connectivity. The connectors are: Main (Power, Ethernet, Serial, HDMI and analog output), Input Channels 0 and 1 (Digital Video In, power out, and serial), and the Optional Output Video (Digital Video Out).



Figure 1: 3000-OEM Overview



3.1 3000-OEM Specifications

| | |
|-----------------------|---|
| Revision | B4 - Current production version (green) |
| Dimensions: | 3.465 in x 1.969 in (88 mm x 50 mm) |
| Weight: | 38 grams |
| Voltage (VIN): | 8 - 15V DC (12V Nominal) ¹ |
| Power: | < 10 Watts with 12V nominal DC input |
| Drawings: | 3000-OEM Drawings* 3000-OEM Assembly |
| STEP Files: | 3000-OEM STEP Files* |

*Includes all production release revisions.

i IMPORTANT: The supply voltage level must be compatible with camera adapter board and connected cameras. For example, the 3000-Sony camera adapter board passes supply voltage directly to the attached camera. A Sony EH series camera can only support 6V - 12V, which would limit the supply voltage of the 3000-OEM to this range.

3.2 Hardware Revisions

Table 1: 3000-OEM Revision Changes

| Board Revision | Changes |
|----------------|--|
| Rev B4 | New production baseline starting Q3,2020. Based on previous Rev B baseline. Removes power control of C66. Mounting holes 0.079 dia. |
| Rev C3 | Disabled Power control of C66. Form and Fit identical to Rev C2. No longer available. |
| Rev C2 | Mounting hole size increased from .063 to .079 dia. to support standard size #1 hardware in addition to M1.6 hardware. Availability limited to existing program support. |
| Rev C1 | Added a power control circuit to allow integrators to turn off the C66 DSP processor. Mounting holes 0.063 dia. No longer available. |
| Rev B3 | Initial production release. Mounting holes 0.063 dia. No longer available. |

3000-OEM board mounting holes support M1.6 screws and standard #1 hardware with revisions C2 and B4 (increase hole size to 0.079).

3.3 Interface Protocol

The 3000-OEM shares the same interface protocol as other SightLine OEM platforms. The protocol is a packet-based command and control interface. There is an ARM core on the DM8148 that is only lightly utilized during implementation. This provides customers with a processor to implement other processing functions or protocol conversions, i.e., allows communications through customized proprietary protocols.

¹ A slightly extended input voltage range is possible with some tradeoffs. Contact [Support](#) for more information if this is relevant to your application.



3.4 Functional Block Diagram

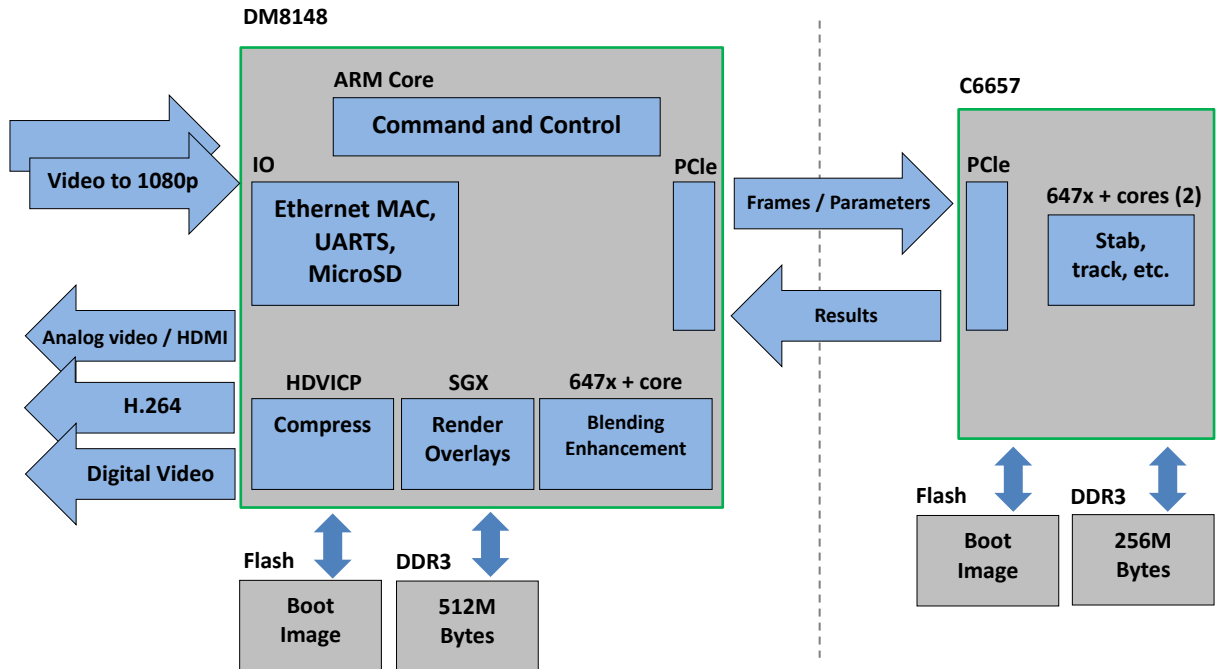


Figure 2: 3000-OEM Hardware Block Diagram

3.5 Design Checklist

- ✓ Provide a sufficient heat sink for the DSP and other major components
- ✓ Expose serial port 0 to connector for debugging
- ✓ Use serial port 1 for command and control, otherwise use Ethernet port. Alternately serial port 2, 3, 4² can also be used for command and control
- ✓ Expose Ethernet port for debug, command and control, and firmware update capability
- ✓ Expose analog video output and ground for debugging
- ✓ Provide test points for all serial port signals
- ✓ Expose test point for video sync signals
- ✓ Expose microSD card signals for failsafe recovery (future improvements)
- ✓ All serial ports are 3.3V TTL levels (unless otherwise noted)

² This feature may not be available for all software releases.



3.6 PCB Corner Alterations

The corners of the 3000-OEM board can be removed or rounded off if needed. A needle file works best for this procedure.

- IMPORTANT:** Considerable care should be taken when removing or rounding off the corners to prevent damage to the board.

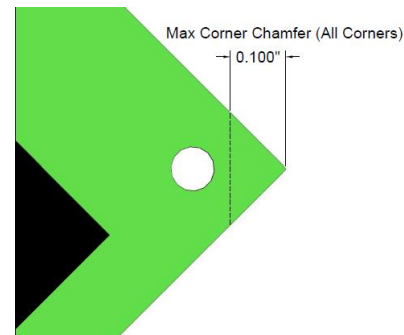


Figure 3: Corner Alterations

4 Thermal Management

4.1 Heatsink Guidelines

- The component temp range is -40°C to 85°C.
- All hardware uses some form of mechanical heatsink.
- A large heatsink to facilitate bench and early testing is provided by SightLine. It supports convective cooling when there is airflow.
- IMPORTANT:** The large heatsink is not intended for long term vehicle integration use.
- If designing a custom heatsink for integration, it should provide a direct conducted path to a significant thermal mass (typically the wall of a gimbal or housing).
- If there is enough airflow, finned options are available. Fin design should be selected based on airflow and available space.
- The 3000-OEM does not have an automatic thermal processor shutdown but does have a temperature sensor. See the [Temperature Sensor - U4](#) section for more information.

[STEP files](#) for the heatsink interface are available from SightLine that can help with heatsink design and integration.

Use gap pads (recommended) or thermal grease to fill gaps between the hot components.

4.2 Gap Pads

Use some form of thermally conductive material for filling gaps between the hot components and the heat sink. Examples such as the [Bergquist VO Ultra Soft](#) are recommended. The SightLine heat sink design assumes that gap pads are used (see [Table 2](#) and [Figure 4](#)). This is preferable in systems with stacked boards. The compression of the pad allows for greater tolerances. The compression of the gap pad also provides additional support for the board and does not require as much force to maintain contact.

- IMPORTANT:** Do not use gap pads in conjunction with thermal grease.



Table 2: Thermal Pads

| Thermal Pads | Manufactures PN | Description | MFG |
|--------------|-----------------------|---|-----------|
| SLA-PAD-010 | GP1500R-0.010-02-0816 | Thermal Pad Black 1.0 X 1.0 x 0.010 - inch Tacky - Both Sides | Bergquist |
| SLA-PAD-125 | GPVOUS-0.125-00-0816 | Thermal Pad Pink 0.250 X 0.250 x 0.125 – inch | Bergquist |
| SLA-PAD-020 | GPVOUS-0.020-00-0816 | Thermal Pad Pink 0.75 X 0.75 x 0.020 – inch | Bergquist |

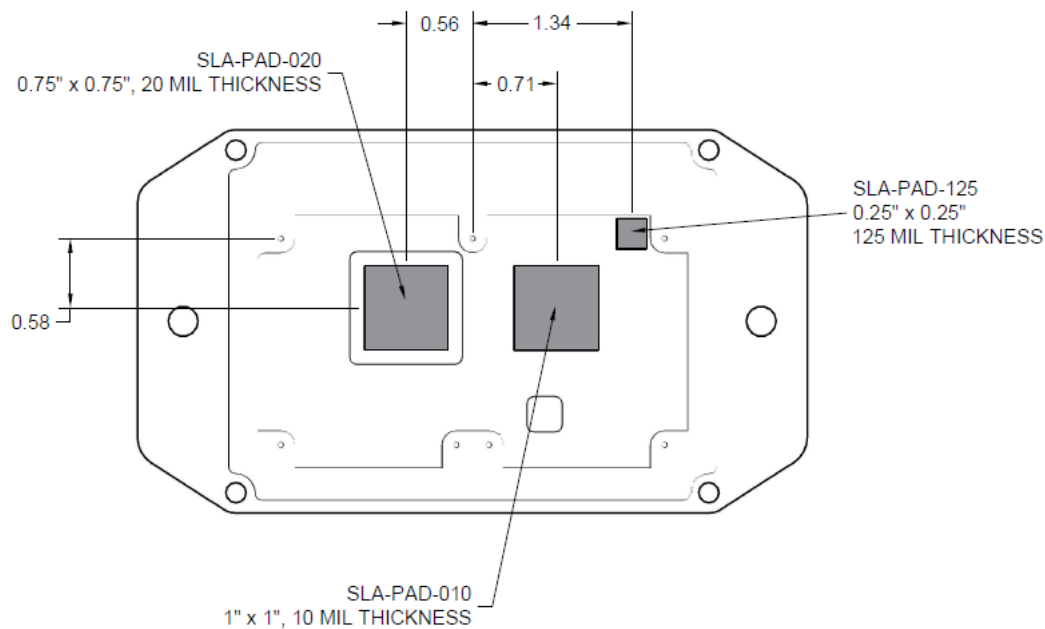


Figure 4: 3000-OEM Thermal Pad Placement

See [3000-OEM Assembly drawing](#) for additional information.

4.3 Gap Filler (Thermal Grease)

The use of thermal grease is not recommended. If needed use some form of thermally conductive liquid gap filling material such as [Artic Silver](#) rather than an adhesive. See the link for recommended application instructions. This should be spread thinly and evenly because of tighter tolerances that are required in a stacked board system using standoffs.

Air bubbles and patches that do not make contact are a common problem when using gap filler. This can additionally create problems on the board if too much is used, or when reassembling systems.

Typically gap filler is used with a spring type system that maintains a known amount of force on the board to maintain contact with the heat sink. While gap filler can be easier to use and provide better thermal conductivity, it is also prone to issues that can make it difficult to achieve these advantages in practice.

Use 99% isopropyl alcohol to clean off thermal grease.

IMPORTANT: Do not to use thermal grease in conjunction with gap pads.



4.4 Preliminary Junction-to-Case Thermal Resistance (Theta-JC)

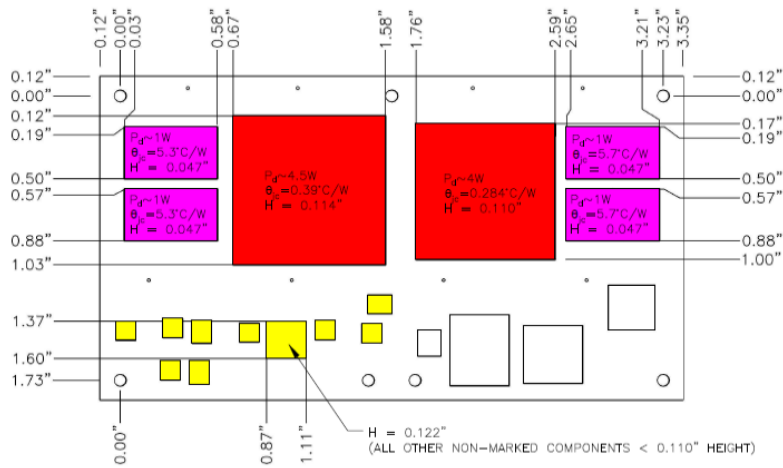


Figure 5: 3000-OEM Thermal Drawing (REV B4)

Drawing notes:

- All dimensions in inches.
- Devices in yellow dissipate less than 1/4W per IC.
- All height (H) values are estimates. Since there is a lot of variation, use gap pads to make good contact.

Table 3: Component Thermal Resistance Specifications

| Description | Manufactures PN | Temp Range | Theta-JC |
|--------------------------|-----------------------|---------------|-----------|
| DM8148 | TMS320DM8148CCYEA0 | -40° to 105°C | 0.39 C/W |
| ISSI memory (for 8148) | IS43TR16128A-15HBLI | -40° to 95°C | 5.3 C/W |
| C6657 | TMS320C6657CZHA25 | -40° to 100°C | 0.284 C/W |
| Micron memory (for 6657) | MT41J64M16JT-15E IT:G | -40° to 95°C | 5.7 C/W |

4.5 Temperature Sensor - U4

The 3000-OEM does not have an automatic thermal processor shutdown. Temperature is read by an onboard NXP LM75BGD digital temperature sensor. The temperature is queried once per second. The operating temperature of the unit can be read through the [SLAGetVersionNumber \(0x00\)](#) command. The temperature can also be reported continually using the [SystemStatusMessage \(0x87\)](#) command. See the [IDD](#) for more information.

To get an accurate reading, the U4 sensor chip should share the same heatsink as the DSPs.

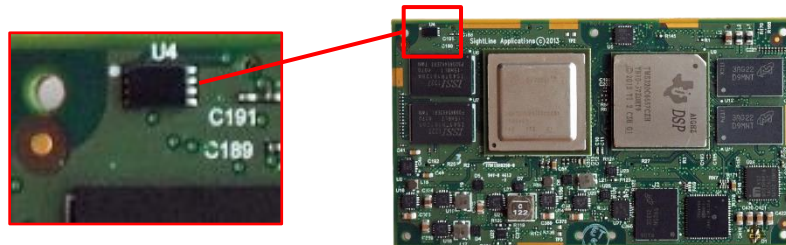


Figure 6: Temperature Sensor



5 Additional I/O

5.1 LEDs

| Label | Color | Function |
|-------|-------|--|
| D2 | Green | Ethernet PHY Activity Indicator (RX / TX) |
| D3 | Amber | Ethernet PHY Link Indicator (Blinking indicates poor link) |
| D8 | Green | GP0[21] Pin K7 [REV C] |
| D9 | Blue | GP0[26] Pin H5 [REV C] |

5.2 Serial Ports

All serial ports are 3.3V TTL. When using a SightLine adapter board with a 3-pin connector, use the CAB-03xx for easy break out to either a pig tail, Molex-to-Molex, or DB-9 connector.

Table 4: 3000-OEM Serial Port Summary

| Connector | Name | Device | Notes |
|-----------|---------------|------------|------------------------------|
| J1 | Serial Port 0 | /dev/ttyO0 | Reserved for SightLine debug |
| J1 | Serial Port 1 | /dev/ttyO1 | |
| J2 | Serial Port 4 | /dev/ttyO4 | |
| J3 | Serial Port 2 | /dev/ttyO2 | |
| J4 | Serial Port 3 | /dev/ttyO3 | |

Table 5: 3000-OEM Serial Ports

| Serial Ports | Serial 0 | | | Serial 1 | | | Serial 2 | | | Serial 3 | | | Serial 4 | | |
|--------------------|----------------|--------|-------|----------------|--------|-------|----------------|--------|-------|----------------|--------|-------|----------------|--------|-------|
| | Connector, Pin | | | Connector, Pin | | | Connector, Pin | | | Connector, Pin | | | Connector, Pin | | |
| Hardware Reference | Rx | Tx | level | Rx | Tx | level | Rx | Tx | level | Rx | Tx | level | Rx | Tx | level |
| SLA-3000-OEM | J1, 27 | J1, 28 | 3.3V | J1, 29 | J1, 30 | 3.3V | J3, 65 | J3, 66 | 3.3V | J4, 65 | J4, 66 | 3.3V | J2, 45 | J2, 46 | 3.3V |

5.3 GPIO

GPIO are used to identify the camera input adapter board address attached to connectors J2, J3, J4. See [Connector Descriptions](#) for more information.

After bootup, the GPIO may be used for generic input and output.

Table 6: 3000-OEM GPIO

| GPIO Port: | GPIO 0_8 | GPIO 0_9 | GPIO 0_10 | GPIO 0_14 | GPIO 0_15 | GPIO 0_25 |
|---------------|-----------|-----------|-----------|-----------|-----------|-----------|
| Video Input 0 | J3, 70 | J3, 71 | J3, 72 | J3, 73 | J3, 74 | J3, 69 |
| GPIO Port: | GPIO 0_18 | GPIO 0_19 | GPIO 0_20 | GPIO 1_16 | GPIO 1_17 | GPIO 1_18 |
| Video Input 1 | J4, 73 | J4, 74 | J4, 69 | J4, 70 | J4, 71 | J4, 72 |
| GPIO Port: | GPIO 0_16 | GPIO 0_17 | GPIO 0_22 | GPIO 0_23 | GPIO 0_24 | GPIO 0_28 |
| Video Output | J2, 49 | J2, 50 | J2, 51 | J2, 52 | J2, 53 | J2, 54 |

(All at 3.3V)



5.4 I2C Port Summary

The I2C Ports available for camera control are on the following ports

Table 7: 3000-OEM I2C Port Summary

| Connector | Name | Device | Notes |
|-----------|-----------|------------|---------------------------|
| J2 | I2C Bus 0 | /dev/i2c-1 | Linux I2C bus number is 1 |
| J3 | I2C Bus 0 | /dev/i2c-1 | Linux I2C bus number is 1 |
| J4 | I2C Bus 3 | /dev/i2c-4 | Linux I2C bus number is 4 |

6 Connector Descriptions

Table 8: Connector Descriptions

| Connector | Description |
|------------------------------------|---|
| Connector J1: Main | Power, serial port 0, serial port 1, analog video out, HDMI out, 10/100 Ethernet, microSD |
| Connector J2: Digital Video Output | Digital video out, serial port 4, I2C0 |
| Connector J3: Video Input 0 | Digital video in 0, serial port 2, I2C0, GPIO |
| Connector J4: Video Input 1 | Digital video in 1, serial port 3, I2C3, GPIO |
| P1 | JTAG (internal use only) |

6.1 Connector J1: Main

Connector: DF12(3.0)-60DS-0.5V(86)

Mates with: DF12(3.0)-60DP-0.5V(86)

Table 9: 3000-OEM J1 Pinout

| Pin | Description | Pin | Description | Pin | Description | Pin | Description |
|-----|-------------|-----|-------------|-----|--------------|-----|--------------|
| 1 | Vin | 2 | Ground | 31 | TXPA | 32 | TXPC |
| 3 | Vin | 4 | Ground | 33 | TXNA | 34 | TXNC |
| 5 | Vin | 6 | Ground | 35 | TXPB | 36 | TXPD |
| 7 | Vin | 8 | Ground | 37 | TXNB | 38 | TXND |
| 9 | Vin | 10 | Ground | 39 | Ground | 40 | Ground |
| 11 | Vin | 12 | Ground | 41 | HDMICLK+ | 42 | HDMID1+ |
| 13 | Vin | 14 | Ground | 43 | HDMICLK- | 44 | HDMID1- |
| 15 | Vin | 16 | Ground | 45 | HDMID0+ | 46 | HDMID2+ |
| 17 | Vin | 18 | Ground | 47 | HDMID0- | 48 | HDMID2- |
| 19 | SD0_DAT2 | 20 | SD0_CLK | 49 | HDMI_SCL | 50 | HDMI_SDA |
| 21 | SD0_CD/DAT3 | 22 | SD0_DAT0 | 51 | Ground | 52 | Ground |
| 23 | SD0_CMD | 24 | SD0_DAT1 | 53 | +3.3V (out) | 54 | +3.3V (out) |
| 25 | Ground | 26 | Ground | 55 | +1.8V (out) | 56 | +1.8V (out) |
| 27 | RX0 | 28 | TX0 | 57 | Video Out 0 | 58 | Video Out 1 |
| 29 | RX1 | 30 | TX1 | 59 | Video Ground | 60 | Video Ground |

6.1.1 Serial Ports

On connector J1, serial port 0 and serial port 1 (RX0/TX0, RX1/TX1) are 3.3VTTL. Serial port 0 should be reserved for debugging. Serial port 1 can be used for command and control. TX pins transmit from the 3000-OEM, RX pins receive.



6.1.2 Video Out 0/1

Video Out 0 provides composite video output.

Video Out 1 is reserved to support S-Video (not currently supported).

6.1.3 Ethernet

On connector J1, pin 31 through pin 38 represent the Ethernet connection. Currently only 10/100BASE-T has been implemented (pins 31,33,35,37). 1000BASE-T has not yet been enabled (pins 32, 34, 36, 38).

TXPA/TXNA is sending info from Sightline product., TXPB/TXNB is receiving.

TXPA = TX+ TXNA = TX- TXPB = RX+ TXNB = RX-

The 3000-OEM uses the embedded Ethernet approach. This consists of 0.033uF capacitors placed in series on the Ethernet lines (AC coupled) onboard. There are no Ethernet magnetics on either the 3000-OEM or the 3000-IO. If the distance is less than a few meters and there is a common ground, there should not be any issues with Ethernet connectivity (even in EMI testing).

Application notes on using the embedded Ethernet approach can be found by on the web by searching for microchip capacitive coupling. Even though the search results will yield information not specific to the chip used by SightLine, the same rules apply.

ⓘ IMPORTANT: If the Ethernet needs to be changed to use external magnetics, the OEM board should be modified by changing the board capacitors (and possibly other passives) to zero-ohm jumpers. Contact [Support](#) for modification assistance.

Analog Video output on J1 is incompatible with Digital Video outputs (Vout, HDMI). Contact [Support](#) for more information.

6.2 Connector J2: Digital Video Output

Connector: DF12(3.0)-60DP-0.5V(86) Mates with: DF12(3.0)-60DS-0.5V(86)

Table 10: 3000-OEM J2 Pinout

| Pin | Description | Notes | Pin | Description | Notes |
|-----|--------------|-------------|-----|--------------|--------|
| 1 | VOUT0_CLK | Pixel Clock | 2 | USB0_ID | |
| 3 | Ground | | 4 | USB0_DRVBUS | |
| 5 | VOUT0_GYYC_9 | Y9 | 6 | VOUT0_GYYC_8 | Y8 |
| 7 | VOUT0_GYYC_7 | Y7 | 8 | VOUT0_GYYC_6 | Y6 |
| 9 | VOUT0_GYYC_5 | Y5 | 10 | VOUT0_GYYC_4 | Y4 |
| 11 | VOUT0_GYYC_3 | Y3 | 12 | VOUT0_GYYC_2 | Y2 |
| 13 | Ground | | 14 | Ground | |
| 15 | VOUT0_BSBC_9 | CbCr9 | 16 | VOUT0_BSBC_8 | CbCr8 |
| 17 | VOUT0_BSBC_7 | CbCr7 | 18 | VOUT0_BSBC_6 | CbCr6 |
| 19 | VOUT0_BSBC_5 | CbCr5 | 20 | VOUT0_BSBC_4 | CbCr4 |
| 21 | VOUT0_BSBC_3 | CbCr3 | 22 | VOUT0_BSBC_2 | CbCr2 |
| 23 | Ground | | 24 | Ground | |
| 25 | VOUT0_RSR_9 | 0 | 26 | VOUT0_RSR_8 | 0 |
| 27 | VOUT0_RSR_7 | 0 | 28 | VOUT0_RSR_6 | 0 |
| 29 | VOUT0_RSR_5 | Y1 = 0 | 30 | VOUT0_RSR_4 | Y0 = 0 |



(3000-OEM J2 Pinout continued)

| Pin | Description | Notes | Pin | Description | Notes |
|-----|-------------|--|-----|-------------|-----------|
| 31 | VOUT0_RSR_3 | CbCr1 = 0 | 32 | VOUT0_RSR_2 | CbCr0 = 0 |
| 33 | Ground | | 34 | Ground | |
| 35 | VOUT0_HSYNC | H Sync | 36 | USB0_DP | |
| 37 | VOUT0_VSYNC | V Sync | 38 | USB0_DM | |
| 39 | VOUT0_FLD | Field | 40 | USB0_VBUSIN | |
| 41 | VOUT0_AVID | Active Video (see Active Video Area and Blanking) | 42 | USB0_CE | |
| 43 | Ground | | 44 | Ground | |
| 45 | RX4 | | 46 | TX4 | |
| 47 | I2C0_SCL | | 48 | I2C0_SDA | |
| 49 | GPO_16 | | 50 | GPO_17 | |
| 51 | GPO_22 | | 52 | GPO_23 | |
| 53 | GPO_24 | | 54 | GPO_28 | |
| 55 | +3.3V (out) | | 56 | +3.3V (out) | |
| 57 | Ground | | 58 | Ground | |
| 59 | +1.8V (out) | | 60 | +1.8V (out) | |

See [Video Output](#) for output video format details.

6.3 Connector J3: Video Input 0 (VIN0)

Connector: DF12(3.0)-80DP-0.5V(86) Mates with: DF12(3.0)-80DS-0.5V(86)

All input signals are assumed to be 3.3V TTL level. Any conversion from a VIOSEL voltage level will be done on the external adapter boards, e.g., SLA-3000-FPC.

Column key for connector J3 pinout:

Y = luminance **G** = Grayscale **B** = Denotes Port B data bits
CbCr = Chrominance **A** = Indicates Port A data bits See [Color Camera Data Input Signal Locations](#)

Table 11: 3000-OEM J3 Pinout

| Pin | Description | Notes | Pin | Description | Notes |
|-----|-------------|----------------|-----|-------------|----------------|
| 2 | VIN0_BCLK | | 1 | VIN0_ACLK | |
| 4 | Ground | | 3 | Ground | |
| 6 | VIN0_D22 | | 5 | VIN0_D23 | |
| 8 | VIN0_D20 | | 7 | VIN0_D21 | |
| 10 | VIN0_D18 | | 9 | VIN0_D19 | |
| 12 | VIN0_D16 | | 11 | VIN0_D17 | |
| 14 | Ground | | 13 | Ground | |
| 16 | VIN0_D14 | Y6, G6, B6 | 15 | VIN0_D15 | Y7, G7, B7 |
| 18 | VIN0_D12 | Y4, G4, B4 | 17 | VIN0_D13 | Y5, G5, B5 |
| 20 | VIN0_D10 | Y2, G2, B2 | 19 | VIN0_D11 | Y3, G3, B3 |
| 22 | VIN0_D8 | Y0, G0, B0 | 21 | VIN0_D9 | Y1, G1, B1 |
| 24 | Ground | | 23 | Ground | |
| 26 | VIN0_D6 | CbCr6, G14, A6 | 25 | VIN0_D7 | CbCr7, G15, A7 |
| 28 | VIN0_D4 | CbCr4, G12, A4 | 27 | VIN0_D5 | CbCr5, G13, A5 |
| 30 | VIN0_D2 | CbCr2, G10, A2 | 29 | VIN0_D3 | CbCr3, G11, A3 |
| 32 | VIN0_D0 | CbCr0, G8, A0 | 31 | VIN0_D1 | CbCr1, G9, A1 |



(3000-OEM J3 Pinout continued)

| Pin | Description | Notes | Pin | Description | Notes |
|-----|--------------------|------------------------|-----|-----------------|--|
| 34 | Ground | | 33 | Ground | |
| 36 | NC | | 35 | NC | Pins 35, 37, 39, 41 have alternate functionality not yet implemented. When building an adapter board DO NOT CONNECT. |
| 38 | NC | | 37 | NC | |
| 40 | NC | | 39 | NC | |
| 42 | Port ID (out) | See pin notes below | 41 | NC | |
| 44 | Ground | | 43 | Ground | |
| 46 | NC | | 45 | VINO_HSYNC | |
| 48 | NC | | 47 | VINO_VSYNC | |
| 50 | NC | | 49 | VINO_FLD | |
| 52 | NC | | 51 | VINO_DE | Optional |
| 54 | Ground | | 53 | Ground | |
| 56 | Passthrough ground | | 55 | Passthrough VIN | See J1* |
| 58 | Passthrough ground | | 57 | Passthrough VIN | See J1* |
| 60 | Passthrough ground | | 59 | Passthrough VIN | See J1* |
| 62 | Passthrough ground | | 61 | Passthrough VIN | See J1* |
| 64 | Ground | | 63 | Ground | |
| 66 | TX2 | 3.3V TTL | 65 | RX2 | 3.3V TTL |
| 68 | I2CO_SDA | /dev/i2c-1 | 67 | I2CO_SCL | /dev/i2c-1 |
| 70 | GP0_8_ID1 | /sys/class/gpio/gpio8 | 69 | GP0_25_ID0 | /sys/class/gpio/gpio25 |
| 72 | GP0_10_ID3 | /sys/class/gpio/gpio10 | 71 | GP0_9_ID2 | /sys/class/gpio/gpio9 |
| 74 | GP0_15 | /sys/class/gpio/gpio15 | 73 | GP0_14 | /sys/class/gpio/gpio14 |
| 76 | +3.3V (out) | | 75 | +3.3V (out) | |
| 78 | Ground | | 77 | Ground | |
| 80 | +1.8V (out) | | 79 | +1.8V (out) | |

*Max voltage = VIN (See [Specifications](#) and connector J1) Max current = 1.2A

Connector pin notes:

- Port ID = Ground for VINO. This is used to identify the port (VINO(J3) or Vin1(J4)) to an external board attached to this port.
- Board ID pins (**ID0**, **ID1**, **ID2**, **ID3**) are used to identify the type of board attached to this connector. See [Camera Input Adapter Board](#) section for details. These GPIO pins will have varied functionality at power up. It recommended to use other available GPIO pins for general purpose if possible.
- Passthrough VIN and ground are passed through from main connector (J1) VIN and ground.
- See [Video Input Port Description](#) for details.

6.4 Connector J4: Video Input 1 (VIN1)

Connector: DF12(3.0)-80DP-0.5V(86) Mates with: DF12(3.0)-80DS-0.5V(86)

Similar pin-out as J3, except for the following:

PortID = +3.3V for Video Input 1, VINx = VIN1 for Video Input 1



Table 12: Video Input Pins

| Pin | Description | Notes | Pin | Description | Notes |
|-----|-------------|------------------------|-----|-------------|------------------------|
| 66 | TX3 | 3.3V TTL | 65 | RX3 | 3.3V TTL |
| 68 | I2C3_SDA | /dev/i2c-4 | 67 | I2C3_SCL | /dev/i2c-4 |
| 70 | GP1_16_ID1 | /sys/class/gpio/gpio48 | 69 | GPO_20_ID0 | /sys/class/gpio/gpio20 |
| 72 | GP1_18_ID3 | /sys/class/gpio/gpio50 | 71 | GP1_17_ID2 | /sys/class/gpio/gpio49 |
| 74 | GPO_19 | /sys/class/gpio/gpio19 | 73 | GPO_18 | /sys/class/gpio/gpio18 |

Connector pin notes:

- Port ID = +3.3 for VIN1. This is used to identify the port (VIN0(J3) or Vin1(J4)) to an external board attached to this port.
- Board ID pins (ID0, ID1, ID2, ID3) are used to identify the type of board attached to this connector. See [Camera Input Adapter Board](#) section for details. These GPIO pins will have varied functionality at power up. It recommended to use other available GPIO pins for general purpose if possible.
- Passthrough VIN and ground are passed through from main connector (J1) VIN and ground.
- See [Video Input Port Description](#) for details.

6.5 Connector J5: JTAG, JTAG, PIC Programmer - **SIGHTLINE USE ONLY**

Connector: ZF5S-25-01-T-WT-TR

Test Points:

| Label | Signal |
|-----------------|--------|
| TP1 / TP2 / TP3 | Ground |

7 Video Output Port Description

7.1 Signal Levels

Unless otherwise specified, all video signal levels are 3.3 Volts.

See the [3000-4000-OEM Camera Input Adapter Board ID Table](#) in [ICD-3000-4000-Adapter-Boards](#) for a list of camera input adapter boards and IDs.

7.2 Power

There are multiple rails available on the connectors to power an adapter board or accessories. On the 3.3V rail, do not exceed 0.8A. On the 1.8V rail, do not exceed 0.7A.



7.3 Video Output

Vout (J2):

- Digital video output supporting up to 1080p60
- 20 Bit YCbCr (10Y/10CbCr) output, with lower 2 bits of Y and CbCr = 0
 - For 16-bit output, use upper 8 of Y and CbCr
 - YCbCr 4:2:2 format
- Currently only embedded sync has been validated (i.e., not using HSYNC/VSYNC/FLD/AVID).
 - Embedded Sync is BT1120 timing reference signals embedded in the data stream.
- 3000-HDSI-OUT board is a working design example of connecting an encoder to the J2 VOUT port.
- Currently supported resolutions:
 - 720P60/59.94/50
 - 1080P60/59.94/50/30/29.97/25 (continued below)
 - 1080i60
 - 1080i59.94/50 (2.25 release)

HDMI Output (J1):

Compliant with HDMI v2.0 output.

The HDMI output format is specified by the resolution and format specified through Panel Plus. The HDMI output ignores any EDID HDMI format information in the external HDMI sink device. Supported HDMI formats are defined in [SLAVideoDisplay](#) in the [IDD](#).

- ⓘ IMPORTANT:** Digital Video outputs (Vout, HDMI) are incompatible with Analog video output on J1. Some combinations of Vout and HDMI can work simultaneously. Contact [Support](#) for more information.


8 Video Input Port Description

8.1 Overview

The 3000-OEM has 2x 16-bit video input ports - VIN0 / VIN1. Each input port can accept 1x 16-bit signal. The signals are parallel digital video only (sometimes called CMOS video).

Two types of synchronization are supported. Both require a pixel clock along with the data stream:

- Discrete Video Sync Signals: Separates signals for Vertical Sync, Horizontal Sync, Field (interlace) and Data Valid.
- Embedded Sync: Synchronization codes present in the data stream are decoded to derive Vertical and Horizontal Sync and Field (interlaced) information. Data Valid is indicated by the presence of sync codes.
- Details on signals and pin locations are in section below: [Video Formats](#)

 *The 3000-OEM supports interlaced video in Embedded Sync mode only (2.24 software release). Previous testing has indicated that the discrete field signal is inconsistently sampled by the hardware, resulting in swapping of field data over time.*




8.2 Adapter Boards

For acquiring video other than parallel digital video, a set of adapter boards are available to convert popular video signals to parallel digital video for input to the video ports. Details are available in [ICD-3000-4000-Adapter-Boards](#).

Input boards examples:

- Sony serial digital interface (Sony FCB cameras and compatible Tamron cameras)
- HD-SDI camera interface
- HDMI camera interface
- Camera Link camera interface
- Hitachi camera interface
- Analog Video (NTSC and PAL)
- Additionally, parallel video can be acquired using an adapter board that accepts an FFC and FPC cable types. Mating adapter boards are available that attach to specific camera types (Boson, Airborne, etc.)

 *SightLine adapter boards are often used by customers for system development work. The adapter board design is then integrated into a custom IO board that mates with the 3000-OEM.*

8.3 Supported Standards


SMTPE 292 (Digital HD video):

- HD-SDI input adapter board
- Only 8-bits of Y and 8-bits of CrCb are acquired (use upper 8-bits if 10-bit data)
- Embedded sync signals must be used to decode interlaced (field) information. The DSP cannot reliably acquire field information from the VINx_FLD signal.

SMTPE 274 (analog HD video): TI TVP7002 analog to digital supported. Contact [Support](#) for details.

8.4 Signal Levels

Unless otherwise specified, all video signal levels are 3.3 Volts.

 *See the 3000-4000-OEM Camera Input Adapter Board ID Table in [ICD-3000-4000-Adapter-Boards](#) for a list of camera input adapter boards and IDs*

8.5 Power

There are multiple rails available on the connectors to power an adapter board or accessories. On the 3.3V rail do not exceed 0.8A. On the 1.8V rail, do not exceed 0.7A.



8.6 Video Formats

Video synchronization can be accomplished using either Discrete Sync signals or Embedded Sync data.

Discrete Video Sync Signals in signal locations (x= 0,1 for VIN0, VIN1)

- VINx_VSYNC (Vertical sync, start of frame)
- VINx_HSYNC (Horizontal sync, start of line)
- VINx_FLD, (field)
- VINx_DE (Line Valid, this remains high during valid pixels in a line)

Embedded Sync In this case all synchronization information is in the embedded sync codes - only the pixel clock and the data stream are used.

- BT.1120 (HD, 720/1080P)
- BT.656. (SD – 525/625 lines)

Vin0 (J3):

- 16-bit YCbCr (up to 1920 x 1200 @ 60Hz)
- 16-bit grayscale (up to 1920 x 1200 @ 60Hz)
- Embedded sync or discrete sync modes

Vin1 (J4):

- 16-bit YCbCr (up to 1920 x 1200 @ 60Hz)
- 16-bit grayscale (up to 1920 x 1200 @ 60Hz)
- Embedded sync or discrete sync modes

8.6.1 Camera Naming Convention

| | When used as one 16-bit input: | When used as two 8-bit inputs (3000-AB board): |
|------------------|--------------------------------|--|
| Connector | Appears in software as: | Appears in software as: |
| J3 (Vin0) | Camera 0 (Cam 0) | Camera 0 and Camera 1 |
| J4 (Vin1) | Camera 2 (Cam 2) | Camera 2 and Camera 3(N/A) ³ |

8.7 Color Camera Data Input Signal Locations

All signal locations refer to the table in [Connector J3: Video Input 0](#).

16-bit YCbCr 4:2:2

- 8-bit luminance acquired in signal locations Y0->Y7
- 8-bit chrominance in signal locations CbCr0->CbCr7

20-bit YCbCr 4:2:2 (not supported)

Use upper 8-bits of 10-bit data for both Y and CbCr

³ Not currently implemented.



8-bit BT.656 (Generic Digital Camera Switch)

- Single BT.656: Camera input is supported on each Vin0 (Cam 0), Vin1 (Cam 2).
- 8-bits BT.656: Data on signal pins 15->22 (15 = most significant bit) with pixel clock on VIN0_ACLK.
- 10-bit BT.656: Wire the upper 8-bits of 10 into the above locations. This will contain the most significant video data, as well as the SAV and EAV codes.
- If the BT.656 is generated by a decoder chip, e.g., SDI, the decoder must be placed in *Multiplexed Luma/Chroma data output for SD and HD data rates*. The 8-bit output will alternate Y, Cb, Y, Cr ..., instead of having Luma and Chroma on separate 8-bit outputs. BT.656 specifies multiplexed data on a single 8/10-bit output.

If the SDI decoder is powered up at the same time as the 3000, the decoder must be held in reset until the power is up and stable. The 3000-OEM provides GPIO to accomplish this. Contact [Support](#) for more information.

8.8 Grayscale Camera Data

Up to 16-bit (see [Connector J3: Video Input 0](#))

8-bit data in signal locations G0 → G7 (G8 → G15 should be tied low)

14-bit data in signal locations G0 → G13 (G14 → G15 should be tied low)

16-bit data in signal locations G0 → G15

Discrete sync signals in signal locations VIN_x_HSYNC, VIN_x_VSYNC, VIN_x_ACLK, VIN_x_FLD, VIN_x_DE (where x is 0,1)

8.9 Synchronization Signals (Video Input 0 and 1)

The following synchronization signals are used. VIN_x refers to VIN0 or VIN1 depending on video input 0 or 1.

- VIN_x_VSYNC vertical sync: A rising edge (default) indicates the start of a new frame. This can be configured through acquisition parameters to falling edge.
- VIN_x_HSYNC horizontal sync: A rising edge (default) indicates the start of a new line. This can be configured through acquisition parameters to falling edge.
- VIN_x_ACLK pixel clock: Pixel data is sampled on the rising edge. Maximum input rate is 165 MHz. Clock edge is not currently configurable through acquisition parameters.
- VIN_x_FLD: This is the field signal for interlaced video. The 3000-OEM does not currently support interlaced acquisition using the field signal. However, starting in 2.24, the 3000-OEM will support interlaced video in embedded sync mode (still does not use VIN_x_FLD).
- VIN_x_DE: This is line enable or line valid. This signal is high only when active sensor pixel data in a line is available. This signal will be low during vertical and horizontal blanking.

For detailed timing information, see TI document [SPRS647e](#), section 8.10.1 HDVPSS Electrical Data/Timing.



8.10 Active Video Area and Blanking

Digital video signals contain blanking lines at the top of each frame known as vertical blanking. Blank pixels at the start of each line are known as horizontal blanking.

The active picture region is where the pixel data from the sensor is displayed (Figure 6). This example shows there are 45 blanking lines at the start of each frame, and 280 blanking pixels at the start of each row.

Every camera will have different vertical and horizontal blanking values. The same camera, when configured for different resolutions, can have different vertical and horizontal blanking values. Refer to the camera specific technical documentation for the correct settings.

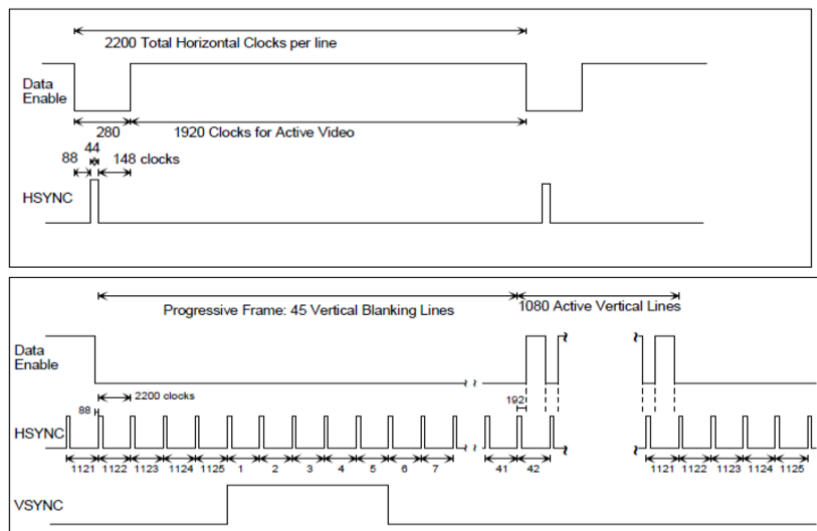
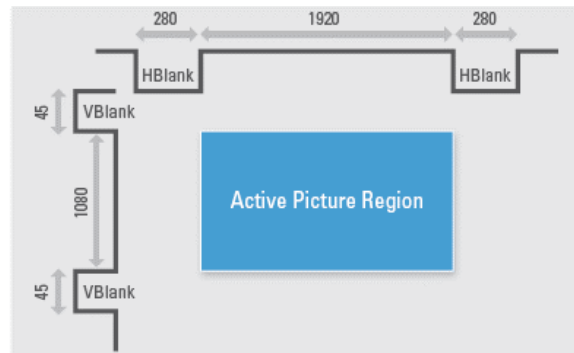


Figure 7: Vertical and Horizontal Blanking

8.10.1 Minimum Vertical Blanking Requirements

720P YCbCr video requires a minimum of 21 vertical blanking lines.

1080P YCbCr video requires a minimum of 30 vertical blanking lines.

ⓘ IMPORTANT: If the vertical blanking requirements are not met, the video may display the color artifacts along the top of the video as shown in Figure 8.



Figure 8: Color Artifacts in Video Example

Corrections:

Increase the vertical blanking of the camera output.

The default capture starts on rising edge of VSync. It is possible to start capture on the falling edge of VSync, which happens earlier, to get enough lines of blanking before active video starts. In Panel Plus, select the *Invert V-Sync Polarity* checkbox in *Acquisition Settings*. In the *Camera Type* drop-down menu, select *Generic Digital* for the camera type.



8.10.2 Removing Blanking Lines and Pixels

Blanking lines and pixels should automatically be removed when the video is acquired by the 3000-OEM.

There are two ways to set up automatic removal. In the *Acquisition Settings* dialog window in Panel Plus, select the *Data Valid Signal* option in *Sync/Crop*, or if the Data Valid Signal is not supported, manually enter the *Vertical* and *Horizontal Front Porch* settings.

Data Valid Signal (if supported)

If the camera's data enable signal goes high when valid pixel data is available (active picture region), in the *Acquisition Settings* dialog, select *Data Valid Signal* in the *Sync/Crop* drop-down menu. Leave *Vertical Front Porch* and *Horizontal Front Porch* set to 0. The 3000-OEM hardware will use the data valid signal to remove blanking lines and pixels from the acquired video.

Generic Digital Settings (Applies to CameraType: Generic Digital Only)

AutoFill

Height Width Resulting Flag Bits **0x401**

Vertical Front Porch: Horizontal Front Porch: Bit Depth:

Input: Gray Scale YUV color G8 16bit in Bayer Laser Interlaced Byte Swap

Invert V-Sync Polarity Invert H-Sync Polarity UB0 Sync/Crop: **Data Valid Signal** ←

Camera Init Code: Options:

Big: Height Width Vertical Blanking Horizontal Blanking

Figure 9: Data Valid Supported

Vertical and Horizontal Front Porch (manual blanking entry)

If the camera does not support Data Valid Signal setting, set the *Sync/Crop* to *None*. Set the *Vertical Front Porch* (blanking) to 45. Set *Horizontal Front Porch* (blanking) to 280.

Generic Digital Settings (Applies to CameraType: Generic Digital Only)

AutoFill

Height Width Resulting Flag Bits **0x1**

Vertical Front Porch: ← Horizontal Front Porch: ← Bit Depth:

Input: Gray Scale YUV color G8 16bit in Bayer Laser Interlaced Byte Swap

Invert V-Sync Polarity Invert H-Sync Polarity UB0 Sync/Crop: **None** ←

Camera Init Code: Options:

Big: Height Width Vertical Blanking Horizontal Blanking

Figure 10: Data Valid Not Supported



If using a custom camera, or a technical reference manual that shows the vertical and horizontal blanking is not available:

1. Set *Vertical Front Porch* and *Horizontal Front Porch* to 0.
2. Turn off stabilization (Panel Plus main menu » *Configure* » *Stabilization* » *Disable All Processing*).
3. Disable *AutoChop* for the camera (Panel Plus main menu » *Configure* » *Margin Chopping*).
4. Save the parameters to the board, and then reboot the system. The network video should be viewable in Panel Plus.
5. Point the camera at a bright white scene. Rows at the top or columns at the left that remain gray are blanking areas.
6. Perform an SD card snapshot with Capture as the source. See [EAN-File Recording](#).
7. Download the snapshot and open it in an image viewer application. Zoom in and count the number of blank lines at the top (vertical blanking) and blank columns at the left (horizontal blanking).
8. If an SD Card snapshot cannot be taken, change the horizontal and vertical blanking values. Save the parameters to the board, and then restart the board. View the video in Panel Plus and repeat until all the blanking lines have been removed.

9 Camera Input Adapter Board IDs

Each SightLine camera adapter board is assigned a unique adapter ID to simplify setup and configuration. This applies to any board connected to J3 or J4 on the [3000-OEM](#) and J6 or J9 on the [4000-OEM](#).

See the 3000-4000-OEM Camera Input Adapter Board ID table in [ICD-3000-4000-Adapter-Boards](#) for a list of camera input adapter boards and IDs.

10 Questions and Additional Support

For questions and additional support, please contact [SightLine Support](#). Additional support documentation and Engineering Application Notes (EANs) can be found on the [Documentation](#) page of the SightLine Applications website.